

LM7905, LM7912, LM7915

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LM79XX Series 3-Terminal Negative Regulators

Check for Samples: LM7905, LM7912, LM7915

FEATURES

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- Thermal, Short Circuit and Safe Area Protection
- **High Ripple Rejection**
- 1.5A Output Current
- 4% Tolerance on Preset Output Voltage

DESCRIPTION

The LM79XX series of 3-terminal regulators is available with fixed output voltages of -5V, -12V, and -15V. These devices need only one external component-a compensation capacitor at the output. The LM79XX series is packaged in the TO-220 power package and is capable of supplying 1.5A of output current.

These regulators employ internal current limiting safe area protection and thermal shutdown for protection against virtually all overload conditions.

Low ground pin current of the LM79XX series allows output voltage to be easily boosted above the preset value with a resistor divider. The low quiescent current drain of these devices with a specified maximum change with line and load ensures good regulation in the voltage boosted mode.

For applications requiring other voltages, see LM137 datasheet.

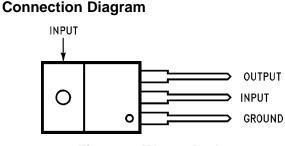
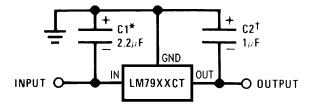


Figure 1. TO-220 Package **Front View** See Package Number NDE0003B

Typical Applications



*Required if regulator is separated from filter capacitor by more than 3". For value given, capacitor must be solid tantalum. 25µF aluminum electrolytic may be substituted.

†Required for stability. For value given, capacitor must be solid tantalum. 25µF aluminum electrolytic may be substituted. Values given may be increased without limit

For output capacitance in excess of 100µF, a high current diode from input to output (1N4001, etc.) will protect the regulator from momentary input shorts.

Figure 2. Fixed Regulator



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Input Voltage	
$(V_o = -5V)$	-25V
$(V_o = -12V \text{ and } -15V)$	-35V
Input-Output Differential	
$(V_o = -5V)$	25V
$(V_o = -12V \text{ and } -15V)$	30V
Power Dissipation ⁽²⁾	Internally Limited
Operating Junction Temperature Range	0°C to +125°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	230°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure Specific Performance limits. For ensured specifications and test conditions, see the Electrical Characteristics.

(2) Refer to DESIGN CONSIDERATIONS for details.

ELECTRICAL CHARACTERISTICS

Conditions unless otherwise noted: $I_{OUT} = 500$ mA, $C_{IN} = 2.2\mu$ F, $C_{OUT} = 1\mu$ F, 0°C $\leq T_J \leq +125$ °C, Power Dissipation ≤ 1.5 W.

Part Number				LM7905C				
Output Voltage				-5V				
	Input Voltage (unle		-10V					
Symbol	Parameter	Conditions	Min	Тур	Max	1		
Vo	Output Voltage	$T_J = 25^{\circ}C$	-4.8	-5.0	-5.2	V		
		$5mA \le I_{OUT} \le 1A$,	-4.75		-5.25	V		
		P ≤ 15W		$(-20 \le V_{\rm IN} \le -7)$	")	V		
ΔV_O	Line Regulation	$T_{\rm J} = 25^{\circ} {\rm C}, \ ^{(1)}$		8	50	mV		
				$(-25 \le V_{\rm IN} \le -7)$	")	V		
				2	15	mV		
				$(-12 \le V_{IN} \le -8)$	3)	V		
ΔV_O	Load Regulation	$T_{\rm J} = 25^{\circ} {\rm C}, \ ^{(1)}$						
		$5mA \le I_{OUT} \le 1.5A$		15	100	mV		
		$250\text{mA} \le I_{OUT} \le 750\text{mA}$		5	50	mV		
l _Q	Quiescent Current	$T_J = 25^{\circ}C$		1	2	mA		
Δl _Q	Quiescent Current	With Line			0.5	mA		
	Change			(−25 ≤ V _{IN} ≤ −7)				
		With Load, $5mA \le I_{OUT} \le 1A$			0.5	mA		
V _n	Output Noise Voltage	T _A = 25°C, 10Hz ≤ f ≤ 100Hz		125		μV		
	Ripple Rejection	f = 120Hz	54	66		dB		
				$(-18 \le V_{\rm IN} \le -8)$	3)	V		
	Dropout Voltage	T _J = 25°C, I _{OUT} = 1A		1.1		V		
I _{OMAX}	Peak Output Current	$T_J = 25^{\circ}C$		2.2		А		
	Average Temperature	I _{OUT} = 5mA,		0.4		mV/°C		
	Coefficient of	0 C ≤ T _J ≤ 100°C						
	Output Voltage							

(1) Regulation is measured at a constant junction temperature by pulse testing with a low duty cycle. Changes in output voltage due to heating effects must be taken into account.



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ELECTRICAL CHARACTERISTICS

Part Number Output Voltage				_M79120	0		C	Units		
				-12V						
	Input Voltage (unless otherwise specified)				-19V			-23V		
Symbol	Parameter	Conditions	Min	Min Typ		Min	Тур	Max		
Vo	Output Voltage	$T_J = 25^{\circ}C$	-11.5	-12.0	-12.5	-14.4	-15.0	-15.6	V	
		$5mA \le I_{OUT} \le 1A$,	-11.4		-12.6	-14.25		-15.75	V	
		P ≤ 15W	(-27	≤ V _{IN} ≤ -	-14.5)	(-30	≤ V _{IN} ≤ -	-17.5)	V	
ΔV _O	Line Regulation	$T_{J} = 25^{\circ}C, (1)$		5	80		5	100	mV	
			(-30	≤ V _{IN} ≤ -	-14.5)	(−30 ≤ V _{IN} ≤ −17.5)			V	
				3	30		3	50	mV	
			(-22	(−22 ≤ V _{IN} ≤ −16)		(−26 ≤ V _{IN} ≤−20)			V	
ΔV_O	Load Regulation	$T_{\rm J} = 25^{\circ} {\rm C}, \ ^{(1)}$								
		$5mA \le I_{OUT} \le 1.5A$		15	200		15	200	mV	
		$250\text{mA} \le I_{OUT} \le 750\text{mA}$		5	75		5	75	mV	
l _Q	Quiescent Current	$T_J = 25^{\circ}C$		1.5	3		1.5	3	mA	
Δl _Q	Quiescent Current	With Line			0.5			0.5	mA	
	Change		(-30	≤ V _{IN} ≤ -	-14.5)	(−30 ≤V _{IN} ≤ −17.5)			V	
		With Load, $5mA \le I_{OUT} \le 1A$			0.5			0.5	mA	
V _n	Output Noise Voltage	T _A = 25°C, 10Hz ≤ f ≤ 100Hz		300			375		μV	
	Ripple Rejection	f = 120 Hz	54	70		54	70		dB	
			(-25	(−25 ≤ V _{IN} ≤ −15)		(−30 ≤ V _{IN} ≤ −17.5)		V		
	Dropout Voltage	$T_{\rm J} = 25^{\circ}C, \ I_{\rm OUT} = 1A$		1.1			1.1		V	
I _{OMAX}	Peak Output Current	$T_J = 25^{\circ}C$		2.2			2.2		Α	
	Average Temperature	I _{OUT} = 5mA,		-0.8			-1.0		mV/°C	
	Coefficient of	0 C ≤ T _J ≤ 100°C								
	Output Voltage									

(1) Regulation is measured at a constant junction temperature by pulse testing with a low duty cycle. Changes in output voltage due to heating effects must be taken into account.

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(1)

DESIGN CONSIDERATIONS

The LM79XX fixed voltage regulator series has thermal overload protection from excessive power dissipation, internal short circuit protection which limits the circuit's maximum current, and output transistor safe-area compensation for reducing the output current as the voltage across the pass transistor is increased.

Although the internal power dissipation is limited, the junction temperature must be kept below the maximum specified temperature (125°C) in order to meet data sheet specifications. To calculate the maximum junction temperature or heat sink required, the following thermal resistance values should be used:

	Тур	Мах	Тур	Мах
Package	θ _{JC}	θ _{JC}	θ _{JA}	θ _{JA}
	°C/W	°C/W	°C/W	°C/W
TO-220	3.0	5.0	60	40

$$P_{D MAX} = \frac{T_{J Max} - T_{A}}{\theta_{JC} + \theta_{CA}} \text{ or } \frac{T_{J Max} T_{A}}{\theta_{JA}}$$

 $\theta_{\rm CA} = \theta_{\rm CS}$ + $\theta_{\rm SA}$ (without heat sink)

Solving for T_J :

$$T_{J} = T_{A} + P_{D} (\theta_{JC} + \theta_{CA})$$

or

 $= T_A + P_D \theta_{JA}$ (without heat sink)

where

- T_J = Junction Temperature
- $T_A = Ambient Temperature$
- P_D = Power Dissipation
- θ_{JA} = Junction-to-Ambient Thermal Resistance
- θ_{JC} = Junction-to-Case Thermal Resistance
- θ_{CA} = Case-to-Ambient Thermal Resistance
- θ_{CS} = Case-to-Heat Sink Thermal Resistance
- θ_{SA} = Heat Sink-to-Ambient Thermal Resistance

Typical Applications

Bypass capacitors are necessary for stable operation of the LM79XX series of regulators over the input voltage and output current ranges. Output bypass capacitors will improve the transient response by the regulator.

The bypass capacitors, $(2.2\mu$ F on the input, 1.0μ F on the output) should be ceramic or solid tantalum which have good high frequency characteristics. If aluminum electrolytics are used, their values should be 10μ F or larger. The bypass capacitors should be mounted with the shortest leads, and if possible, directly across the regulator terminals.

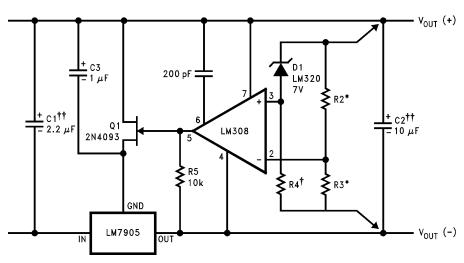
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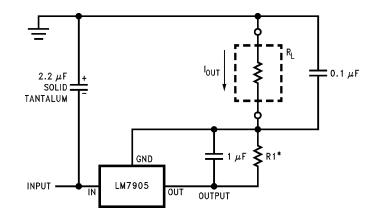
Load and line regulation < 0.01% temperature stability $\leq 0.2\%$

†Determine Zener current

††Solid tantalum

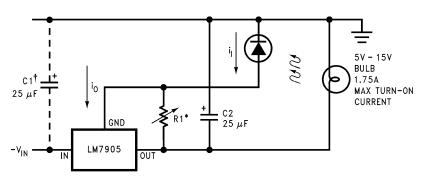
*Select resistors to set output voltage. 2 ppm/°C tracking suggested





 ${}^{\bullet}I_{OUT} = 1 \text{ mA} + \frac{5V}{R1}$





*Lamp brightness increase until $i_l=i_Q (\approx 1 \text{ mA}) + 5 \text{V/R1}$.

†Necessary only if raw supply filter capacitor is more that 2" from LM7905CT

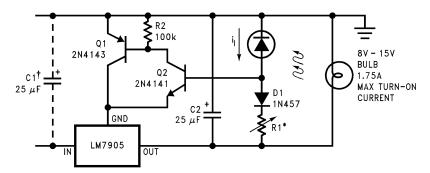
Figure 5. Light Controller Using Silicon Photo Cell

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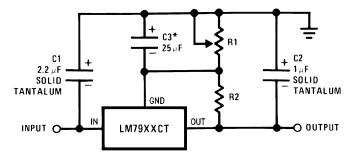
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*Lamp brightness increases until $i_i = 5V/R1$ (I_i can be set as low as 1 µA) †Necessary only if raw supply filter capacitor is more that 2" from LM7905

Figure 6. High-Sensitivity Light Controller



*Improves transient response and ripple rejection. Do not increase beyond 50 $\mu F.$ v_{OUT} = $v_{SET}\left(\frac{R1+R2}{R2}\right)$

Select R2 as follows:

LM7905CT 300Ω LM7912CT 750Ω LM7915CT 1k



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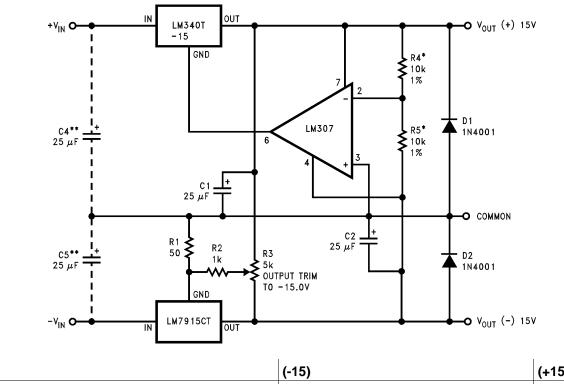
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	(-15)	(+15)
Load Regulation at $\Delta I_{L} = 1A$	40mV	2mV
Output Ripple, $C_{IN} = 3000 \mu F$, $I_L = 1A$	100 μVms	100 μVms
Temperature Stability	50mV	50mV
Output Noise 10Hz ≤ f ≤ 10kHz	150 μVms	150 μVms

*Resistor tolerance of R4 and R5 determine matching of (+) and (-) outputs.

**Necessary only if raw supply filter capacitors are more than 3" from regulators.

Figure 8. ±15V, 1 Amp Tracking Regulators

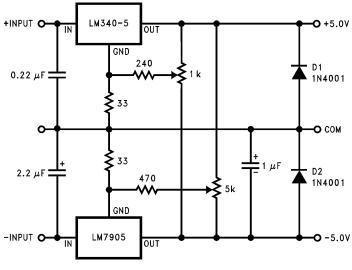


Figure 9. Dual Trimmed Supply

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Schematic Diagrams

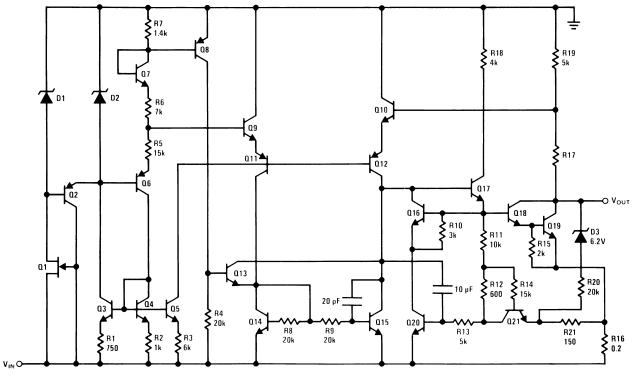
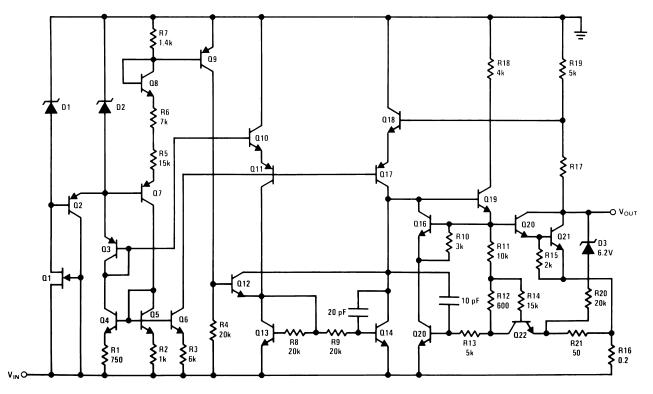
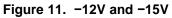


Figure 10. -5V





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REVISION HISTORY

C	hanges from Revision B (May 2013) to Revision C	Page
•	Changed layout of National Data Sheet to TI format.	8

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B (May 2013) to Revision C		



1-Nov-2013

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM7905CT	NRND	TO-220	NDE	3	45	TBD	Call TI	Call TI	0 to 125	LM7905CT	
LM7905CT/NOPB	ACTIVE	TO-220	NDE	3	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	0 to 125	LM7905CT	Samples
LM7912CT	NRND	TO-220	NDE	3	45	TBD	Call TI	Call TI	0 to 125	LM7912CT	
LM7912CT/NOPB	ACTIVE	TO-220	NDE	3	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	0 to 125	LM7912CT	Samples
LM7915CT	NRND	TO-220	NDE	3	45	TBD	Call TI	Call TI	0 to 125	LM7915CT	
LM7915CT/NOPB	ACTIVE	TO-220	NDE	3	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	0 to 125	LM7915CT	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



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PACKAGE OPTION ADDENDUM

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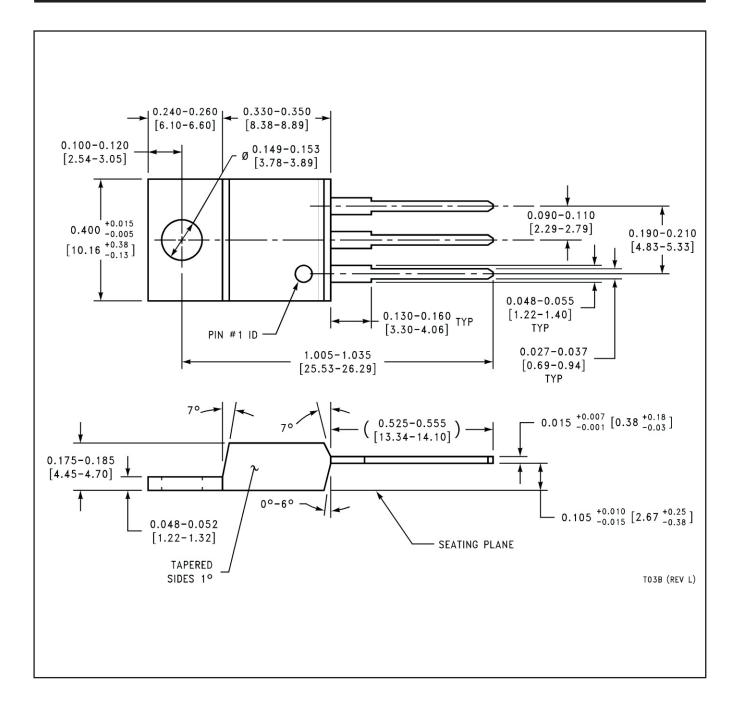
⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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